



17P10-Q

Power MOSFET

-17A, -100V P-CHANNEL POWER MOSFET

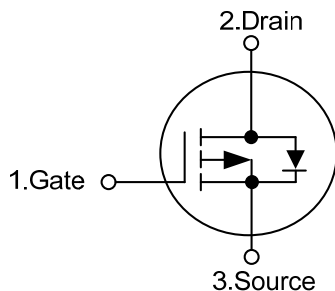
DESCRIPTION

The **17P10-Q** uses advanced proprietary, planar stripe, DMOS technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable to be used in low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

FEATURES

- * $R_{DS(ON)} \leq 0.2 \Omega$ @ $V_{GS} = -10V$, $I_D = -8.5A$
- * Low capacitance
- * Low gate charge
- * Fast switching capability
- * Avalanche energy specified

SYMBOL

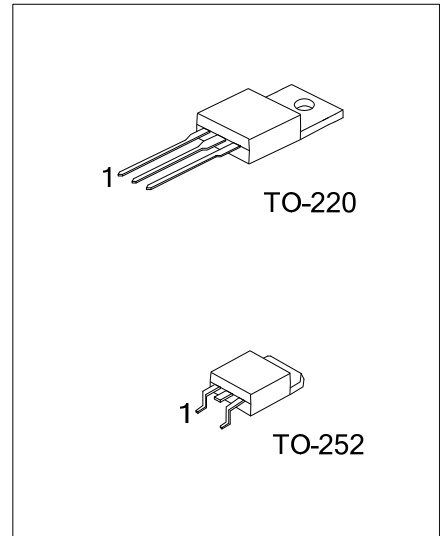


ORDERING INFORMATION

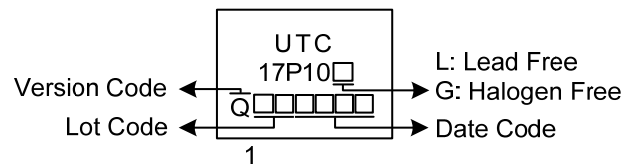
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
17P10L-TA3-T	17P10G-TA3-T	TO-220	G	D	S	Tube
17P10L-TN3-R	17P10G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

17P10G-TA3-T (1) Packing Type (2) Package Type (3) Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
--	---



■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	-100	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current		I_{D}	-17	A
Pulsed Drain Current (Note 2)		I_{DM}	-51	A
Avalanche Current (Note 2)		I_{AR}	-17	A
Single Pulsed Avalanche Energy (Note 3)		E_{AS}	95	mJ
Peak Diode Recovery dv/dt		dv/dt	8.3	V/ns
Power Dissipation	TO-220	P_{D}	100	W
	TO-252		45	W
Junction Temperature		T_{J}	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 1\text{mH}$, $I_{\text{AS}} = -13.75\text{A}$, $V_{\text{DD}} = -50\text{V}$, $R_{\text{G}} = 25\Omega$, Starting $T_{\text{J}} = 25^{\circ}\text{C}$

4. $I_{\text{SD}} \leq -17\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{\text{DD}} \leq BV_{\text{DSS}}$, Starting $T_{\text{J}} = 25^{\circ}\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220	θ_{JC}	1.25	$^{\circ}\text{C}/\text{W}$
	TO-252		2.7	$^{\circ}\text{C}/\text{W}$

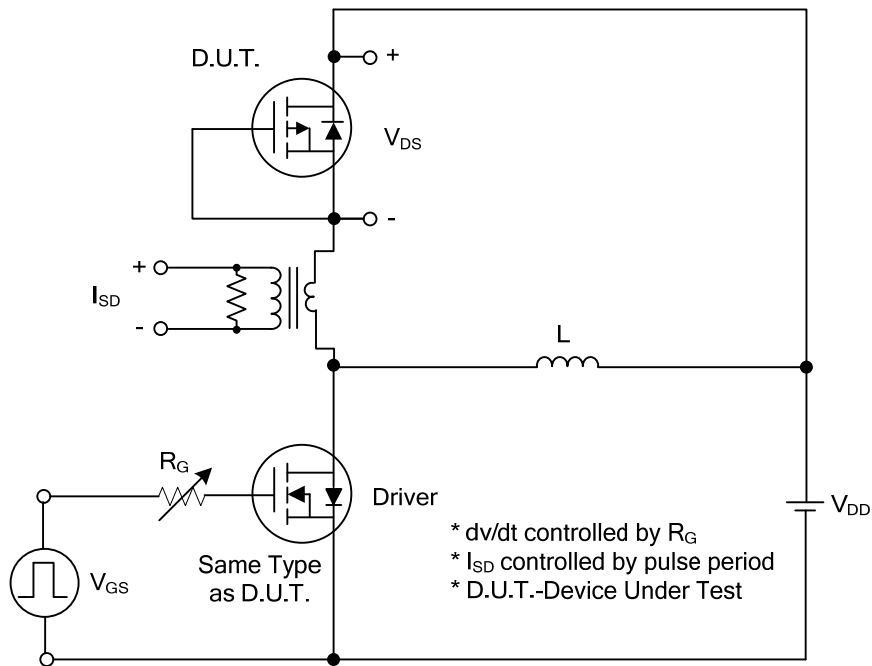
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ **ELECTRICAL CHARACTERISTICS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

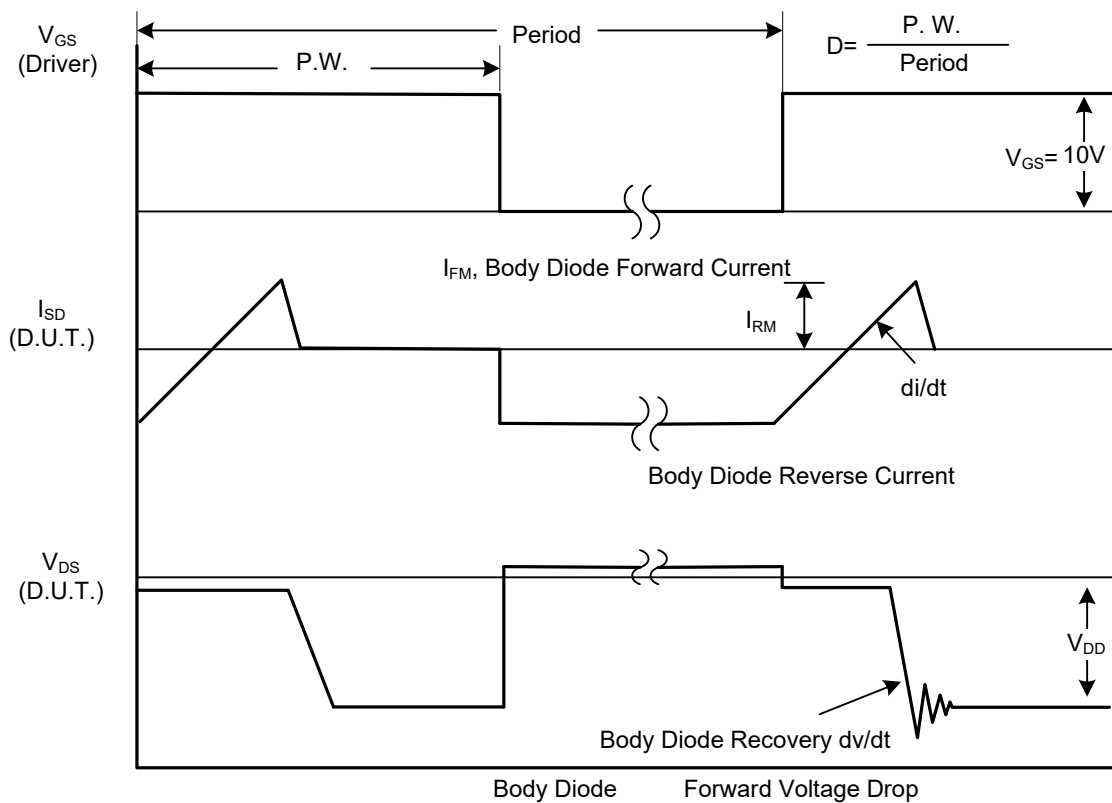
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-100			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V			-1	μA
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±30V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =-250μA	-2.0		-4.0	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-8.5A			0.2	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =-25V, V _{GS} =0V, f=1.0MHz		700		pF
Output Capacitance	C _{OSS}			201		pF
Reverse Transfer Capacitance	C _{RSS}			41		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q _G	V _{DS} =-80V, V _{GS} =-10V, I _D =-17A, (Note 1, 2)		24		nC
Gate Source Charge	Q _{GS}			9		nC
Gate Drain Charge	Q _{GD}			6		nC
Turn-ON Delay Time	t _{D(ON)}	V _{DD} =-50V, V _{GS} =-10V, I _D =-17A, R _G =3.3Ω (Note 1, 2)		7		ns
Turn-ON Rise Time	t _R			18		ns
Turn-OFF Delay Time	t _{D(OFF)}			19		ns
Turn-OFF Fall-Time	t _F			17		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I _S				-17	A
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}				-51	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-17A			-5	V
Body Diode Reverse Recovery Time	t _{rr}	V _{GS} = 0V, I _S =-17A,		163		ns
Body Diode Reverse Recovery Charge	Q _{rr}	dI _F /dt=100A/μs (Note 1)		0.66		μC

Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.
 2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

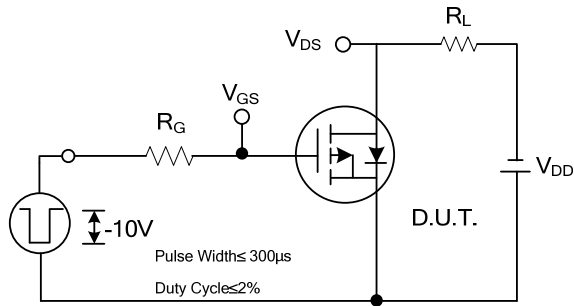


Peak Diode Recovery dv/dt Test Circuit

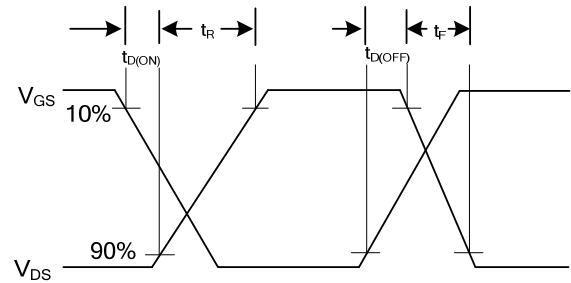


Peak Diode Recovery dv/dt Waveforms

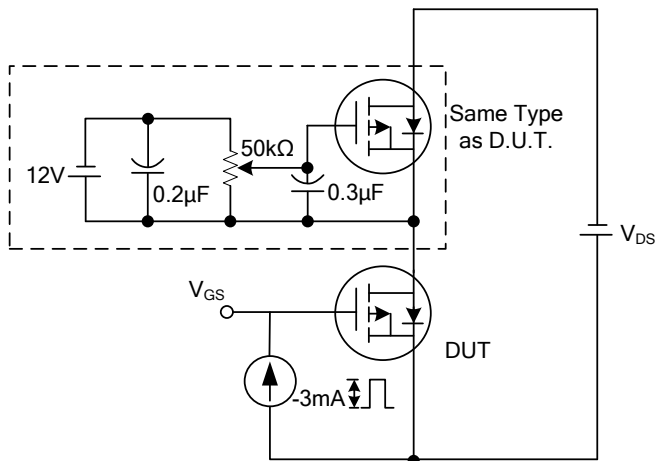
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



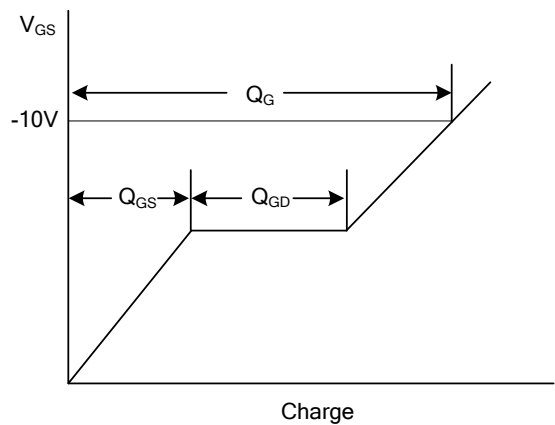
Switching Test Circuit



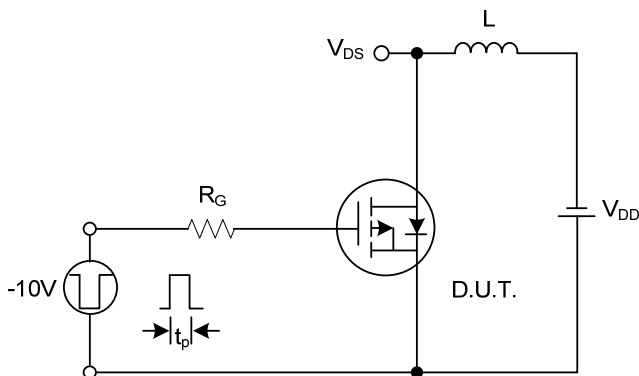
Switching Waveforms



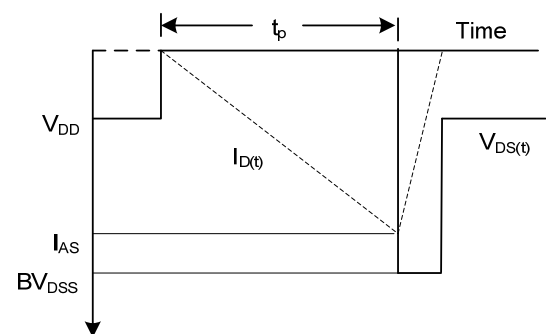
Gate Charge Test Circuit



Gate Charge Waveform

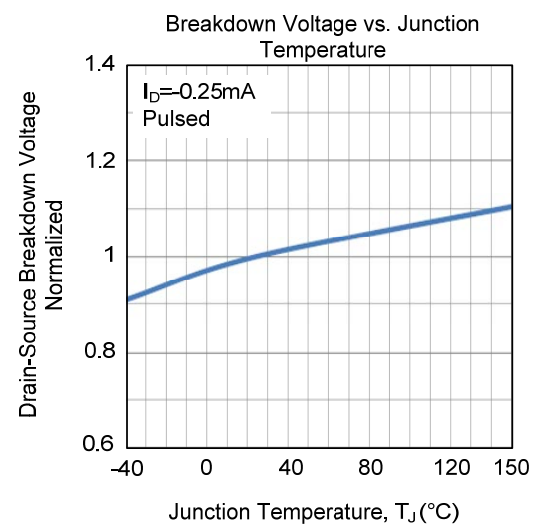
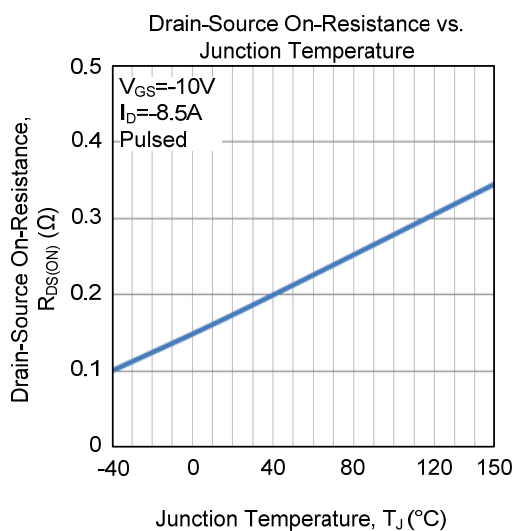
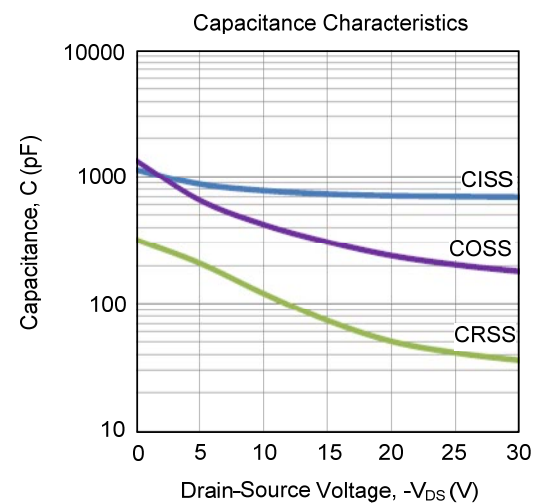
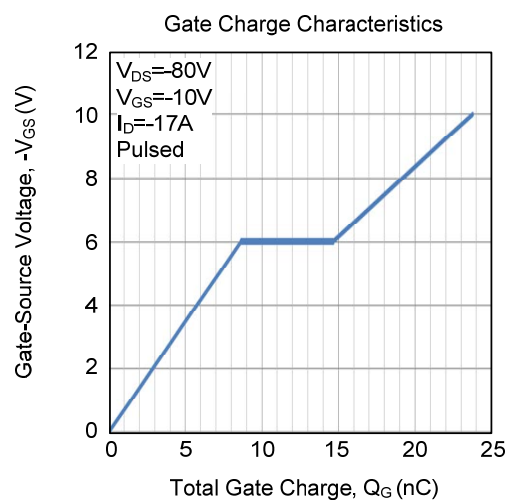
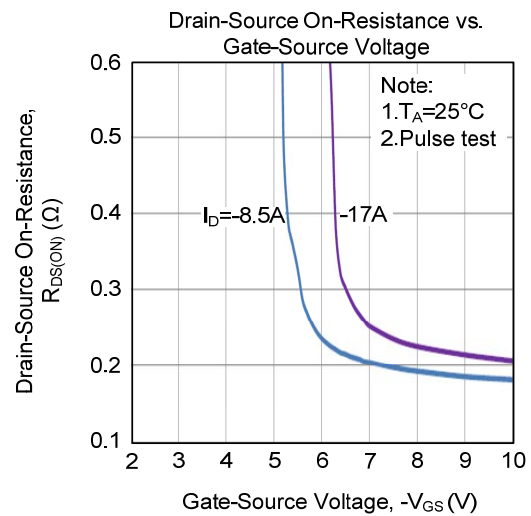
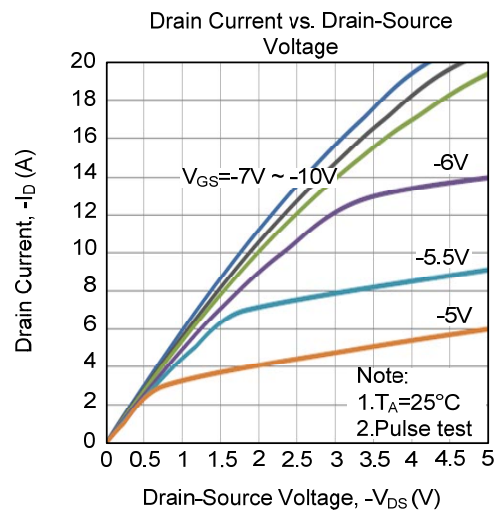


Unclamped Inductive Switching Test Circuit

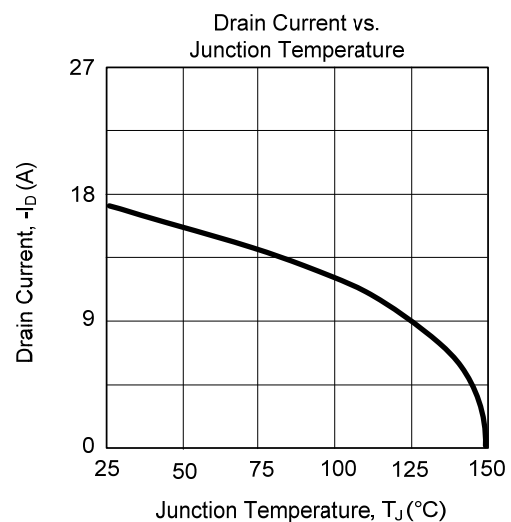
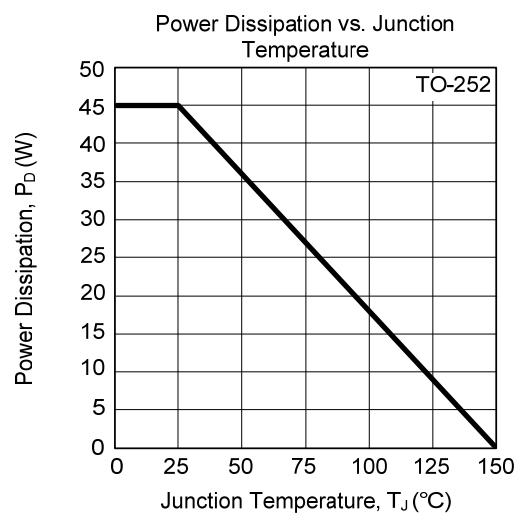
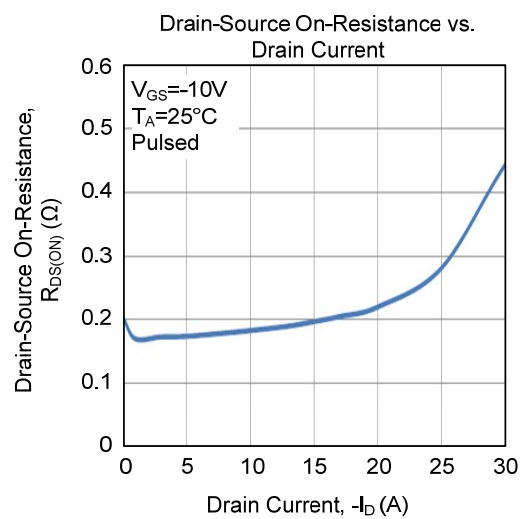
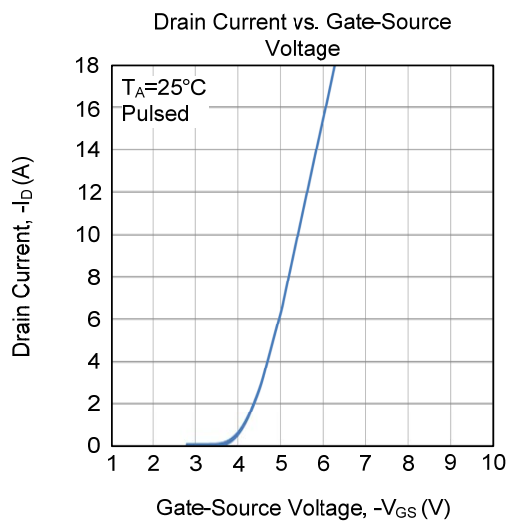
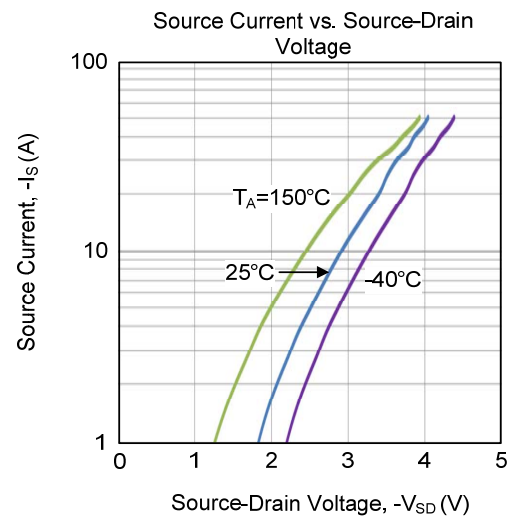
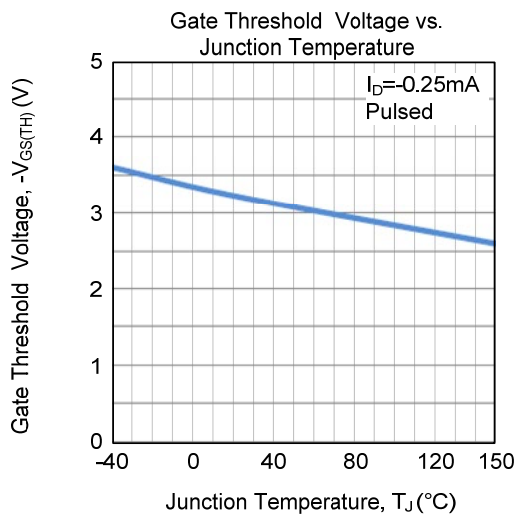


Unclamped Inductive Switching Waveforms

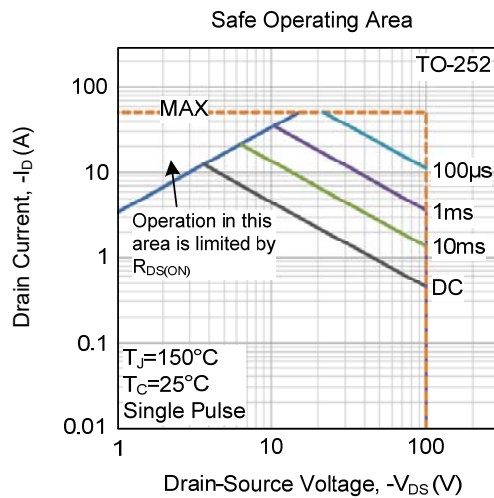
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.